

Product data sheet

1. General description

LED driver consisting of a resistor-equipped PNP transistor with two diodes on one chip in a small SOT23 plastic package.

2. Features and benefits

- Stabilized output current of 20 mA
- High currrent accuracy at supply voltage variation
- Reduces component count and board space
- Qualified according to AEC-Q101

3. Applications

- Constant current LED driver
- Generic constant current source
- Automotive applications

4. Quick reference data

Table 1. Qu	iick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
lo	output current	$\label{eq:VSUP} \begin{array}{l} V_{SUP} = 10 \; V; \; V_{O} = 8.6 \; V; \; T_{amb} = 25 \; ^{\circ}C; \\ pulsed; \; t_{p} \leq 300 \; \mu s; \; \delta \leq 0.02 \end{array}$	17	20	23	mA
V _{SUP}	supply voltage		-	-	18	V





20 mA LED driver in SOT23

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	GND	ground	3	V _{SUP}
2	V _{SUP}	supply voltage		
3	I _O /V _O	output current/output voltage	1 2 TO-236AB (SOT23)	GND aza-019596

6. Ordering information

Table 3. Ordering information					
Type number Package					
	Name	Description	Version		
NCR402T	TO-236AB	plastic surface-mounted package; 3 leads	SOT23		

7. Marking

Table 4. Marking codes	
Type number	Marking code
NCR402T	BF

8. Limiting values

Table 5.Limiting values

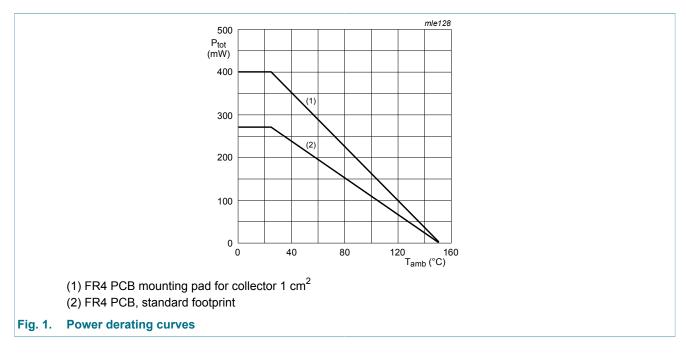
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{SUP}	supply voltage			-	18	V
Vo	output voltage	V _{SUP} = 18 V		-	16	V
V _R	reverse voltage		[1]	-	0.5	V
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	270	mW
			[3]	-	400	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Between all terminals.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB); single-sided copper; tin-plated and standard footprint.

^[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for output 1 cm².



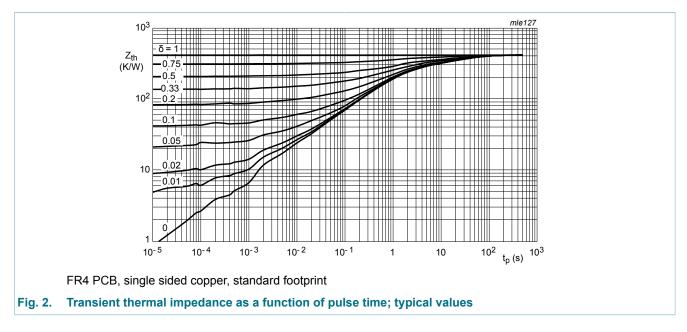
20 mA LED driver in SOT23

9. **Thermal characteristics**

Table 6. The	rmal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)}	thermal resistance	in free air	[1]	-	-	465	K/W
	from junction to ambient		[2]	-	-	312	K/W

[1] [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.

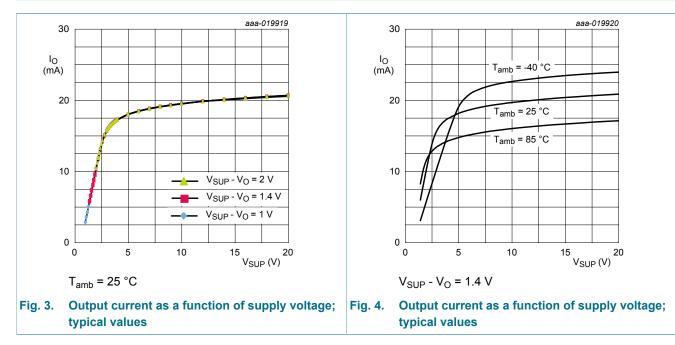
Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for collector 1 cm².



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10. Characteristics

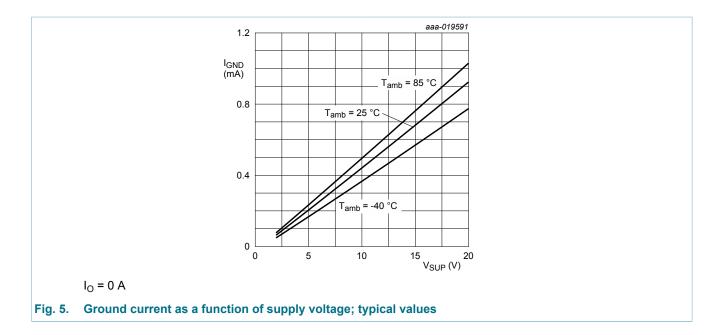
Table 7. Cha	aracteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
lo	output current	$\label{eq:VSUP} \begin{array}{l} V_{SUP} \texttt{=} \ \texttt{10} \ \texttt{V}; \ \texttt{V}_{O} \texttt{=} \texttt{8.6} \ \texttt{V}; \ \texttt{T}_{amb} \texttt{=} \texttt{25} \ \texttt{^{\circ}C}; \\ \texttt{pulsed}; \ \texttt{t}_{p} \texttt{\leq} \texttt{300} \ \texttt{\mu}\texttt{s}; \ \texttt{\delta} \texttt{\leq} \texttt{0.02} \end{array}$	17	20	23	mA
I _{GND}	ground current	$\label{eq:V_SUP} \begin{array}{l} \text{= 10 V; } \text{I}_{\text{O}} = 0 \text{ A; } \text{T}_{\text{amb}} = 25 \ ^{\circ}\text{C;} \\ \text{pulsed; } \text{t}_{\text{p}} \leq 300 \ \text{\mus; } \delta \leq 0.02 \end{array}$	340	420	500	μA
$V_{(VSUP-VO)min}$	minimum voltage between supply voltage and output voltage	I_O > 17 mA; T _{amb} = 25 °C; pulsed; $t_p \le 300 \ \mu$ s; δ ≤ 0.02	-	1.4	-	V
ΔI _O / (I _O ×ΔT _{amb})	relative output current variation with ambient temperature	V_{SUP} = 10 V; V_{O} = 8.6 V; T_{amb} = 25 °C; pulsed; t_{p} ≤ 300 µs; δ ≤ 0.02	-	-0.3	-	%/K
ΔΙ _Ο / (I _O ×ΔV _{SUP})	relative output current variation with supply voltage	$\label{eq:V_SUP} \begin{split} V_{SUP} &= 10 \text{ V}; V_{SUP} \text{ - } V_{O} \text{ = } 1.4 \text{ V}; \\ T_{amb} &= 25 ^{\circ}\text{C}; \text{ pulsed}; t_{p} \text{ \leq } 300 \mu\text{s}; \\ \delta &\leq 0.02 \end{split}$	-	0.8	-	%/V



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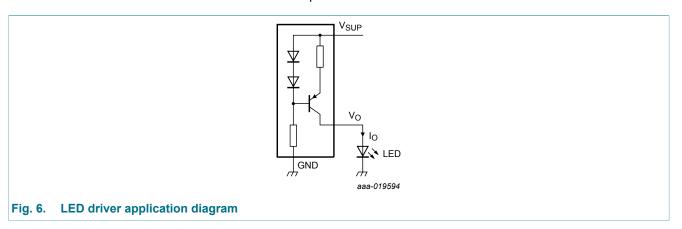
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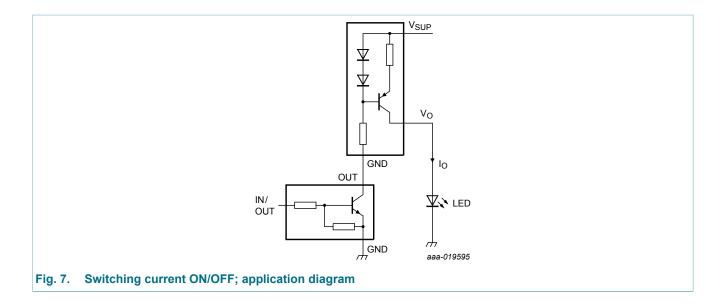
11. Application information

Fig. 6 shows a typical application circuit for an LED driver. The constant current ensures a constant LED brightness. The output current slightly decreases when the power load at the LED driver increases. This effect is due to self heating of the device and the negative thermal coefficient of the output current.



The output can be switched ON and OFF by connecting a Resistor-Equipped Transistor (RET), e.g. PDTC124XU; see Fig. 7

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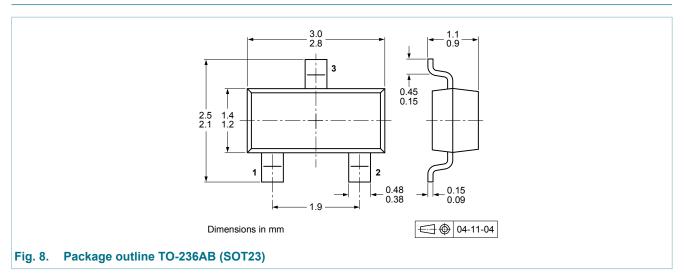


12. Test information

12.1 Quality information

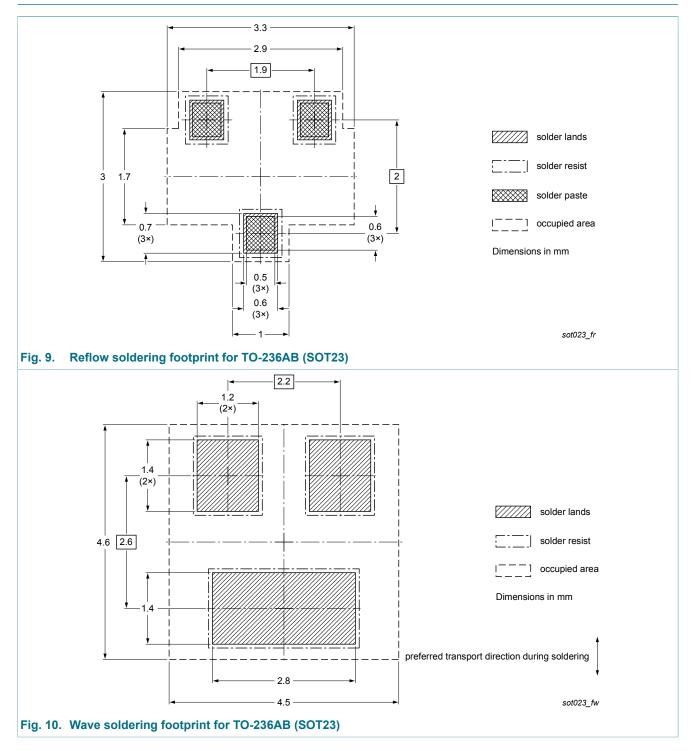
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

13. Package outline



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14. Soldering



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15. Revision history

Table 8. Revision his	8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
NCR402T v.1	20151016	Product data sheet	-	-			

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16. Legal information

16.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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